# RF Driver Amplifier 250 - 4000 MHz



MAAM-009560

Rev. V2

#### **Features**

- Output Intercept Point of +42 dBm over a 20 dB Input Power Range
- Broadband Operation
- Lead-Free SOT-89 Package
- RoHS\* Compliant
- · Class 2 ESD Rating

## **Applications**

- ISM
- Wireless Networking & Communication

## **Description**

The MAAM-009560 RF driver amplifier is a GaAs MMIC which exhibits exceptional linearity performance over a >20 dB dynamic range, as well as featuring high gain in a lead-free miniature SOT-89 surface mount plastic package. The device is biased with a single +5 volt supply and consumes 225 mA typically.

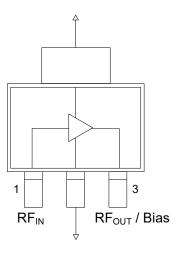
The MAAM-009560 is fabricated using an HBT process to realize low current and high linearity. The process features full passivation for increased performance and reliability.

# Ordering Information<sup>1,2</sup>

Part Number	Package
MAAM-009560-000000	Bulk Packaging
MAAM-009560-TR1000	1000 piece reel
MAAM-009560-TR3000	3000 piece reel
MAAM-009560-001SMB	Sample Board

- 1. Reference Application Note M513 for reel size information.
- 2. All sample boards include 5 loose parts.

#### **Functional Schematic**



## **Pin Configuration**

Pin#	Function
1	RF Input
2	Ground
3	RF Output/Bias

<sup>\*</sup> Restrictions on Hazardous Substances, compliant to current RoHS EU directive.



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## Electrical Specifications: Freq. = 2140 MHz, $T_A = 25$ °C, $V_{CC} = +5$ V, $Z_0 = 50$ $\Omega$

Parameter	Units	Min.	Тур.	Max.
Gain	dB	14	15	_
Noise Figure	dB	_	3	_
Input Return Loss	dB	_	15	_
Output Return Loss	dB	_	17	_
Output P1dB	dBm	_	28.5	_
Output IP3	dBm	40	42	_
Quiescent Current	mA	_	220	_
Current (P <sub>IN</sub> = 0 dBm)	mA	_	225	325

# Maximum Operating Conditions<sup>3</sup>

Parameter	Maximum Operating Conditions
Junction Temperature⁴	170 °C
RF Output Power	28 dBm
Operating Temperature	-40 °C to +85 °C

<sup>3.</sup> These operating conditions will ensure MTTF >  $1 \times 10^6$  hours.

 $T_J = 73~^{\circ}C$  @ 5 V, 225 mA,  $P_{OUT}$  = 20 dBm,  $P_{IN}$  = 5.0 dBm b) For  $T_A$  = 85 $^{\circ}C$  ,

 $T_J$  = 123 °C @ 5 V, 180 mA,  $P_{OUT}$  = 20 dBm,  $P_{IN}$  = 5.5 dBm

# Absolute Maximum Ratings<sup>5,6</sup>

Parameter	Absolute Maximum
RF Output Power	29 dBm
Voltage	6 volts
Storage Temperature	-65 °C to +150 °C
Junction Temperature	210 °C

<sup>5.</sup> Exceeding any one or combination of these limits may cause permanent damage to this device.

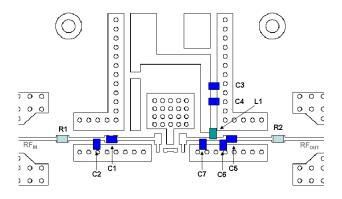
<sup>4.</sup> Junction Temperature ( $T_J$ ) =  $T_A$  +  $\Theta$ jc \* ((V \* I) - ( $P_{OUT}$  -  $P_{IN}$ )) Typical thermal resistance ( $\Theta$ jc) = 47° C/W a) For  $T_A$  = 25°C,

MACOM does not recommend sustained operation near these survivability limits.



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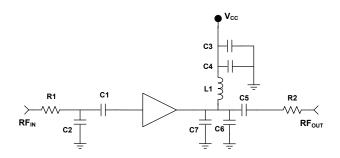
## 2140 MHz PCB Layout



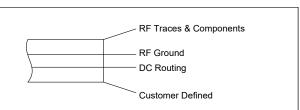
#### **Parts List**

Part	Value	Case Style
C1	1.8 pF	0402
C2	2.2 pF	0402
C3	0.1 μF	0402
C4	1000 pF	0402
C5	39 pF	0402
C6	1 pF	0402
C7	2 pF	0402
L1	3.6 nH	0402
R1, R2	0 Ω	0402

### 2140 Schematic



### **Cross Section View**



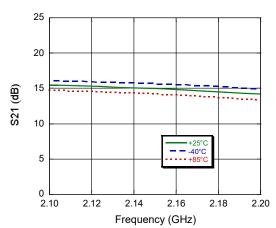
The PCB dielectric between RF traces and RF ground layers should be chosen to reduce RF discontinuities between 50  $\Omega$  lines and package pins. M/A-COM recommends an FR-4 dielectric thickness of 0.008" (0.20 mm) yielding a 50  $\Omega$  line width of 0.015" (0.38 mm). The recommended RF metalization is 1 ounce copper.



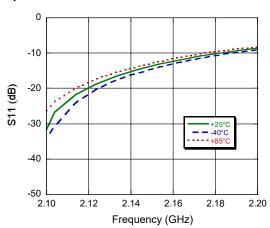
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## **Typical Performance Curves, 2140 MHz Configuration**

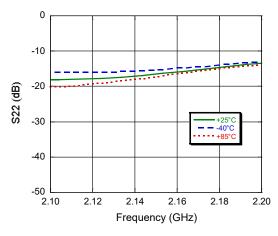
#### Gain



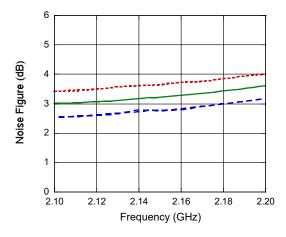
#### Input Return Loss



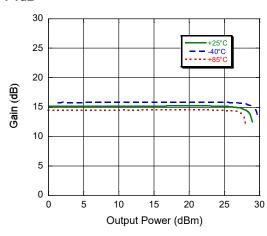
#### **Output Return Loss**



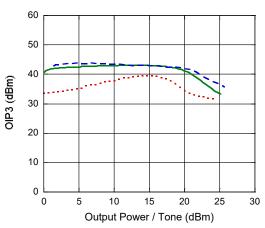
#### Noise Figure



#### P1dB



## **Output IP3**



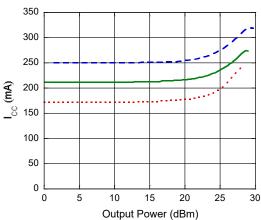
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# Typical Performance Curves, 2140 MHz Configuration

## Current



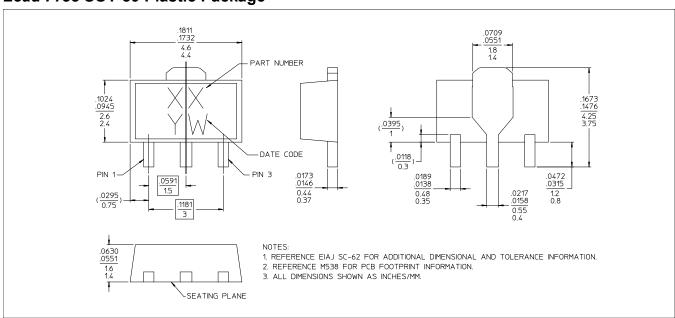
## **Handling Procedures**

Please observe the following precautions to avoid damage:

# **Static Sensitivity**

Gallium Arsenide Integrated Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these class 2 devices.

# Lead-Free SOT-89 Plastic Package<sup>†</sup>



<sup>&</sup>lt;sup>†</sup> Reference Application Note M538 for lead-free solder reflow recommendations. Meets JEDEC moisture sensitivity level 1 requirements. Plating is 100% matte tin over copper.